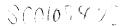
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OMB No. 0651-0027 (exp. 5/31/2002)	10194	15039	
To the Honorable Commissioner of Pat	ents and Trademarks: P	ease record the attached o	original documents or copy thereof
Name of conveying party(ies):		2. Name and address	of receiving party(ies)
Nobuo Sasaki and Masaaki Oka		Name: Sony Computer Entertainment Inc.	
		Internal Address:	
		Street Address:	
Additional name(s) of conveying party(ies) attached?	Yes x No	1-1, Akasaka 7-cho Minato-ku	me
3. Nature of Conveyance:			
x Assignment	Merger		
Security Agreement	Change of Name	City: Tokyo	
Other		State: Japan	Zip: 107-0052
Execution Date: October	19, 2001	Additional name(s) & address(es) attached	Yes X No
4. Application number(s) or patent n	iumber(s):		
If this document is being filed together with A. Patent Application No.(s): 09/935,891	a new application, the exe	B. Patent No.(s):	cation is:
		6. Total number of appl	lications and
Name and address of party to whom correspondence concerning document should be mailed:		patents involved:	1
Name: Robert B. Cohen LERNER, DAVID, LITTENBERG, KRUMHOLZ & MENTLIK, LLP		7. Total fee (37 CFR 3	3.41) \$ 40.00
Internal Address:		Enclosed	
Street Address: 600 South Avenue V	Vest	X Authorized to	be charged to deposit account
		8. Deposit account nu	mber:
			12-1095
City: State: NJ	Zip: 07090	(Attach duplicate copy of t	his page if paying by deposit account)
	DO NOT USE	THIS SPACE	
9. Statement and signature.			
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Robert B. Cohen			
Total number of pages including cover sheet, attachments, and documents: 3			

01/11/2002 DBYRNE 00000150 121095 09935891, \ 01 FC:581 40.00 CH

338056_1 DOC



Docket Number: SCEI 3.0-081 SCEI Ref. No.: SC01054US00

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in:

APPARATUS AND METHOD FOR RENDERING ANTIALIASED IMAGE

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address:

AND WHEREAS, Sony Computer Entertainment Inc., a Japanese corporation with offices at 1-1, Akasaka 7-chome, Minato-ku, Tokyo 107-0052, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto:

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the application number and filing date of this application in the spaces that follow: Application Number: <u>09/935,891</u>, Filing Date: <u>August 23, 2001</u>.

This assignment executed on the dates indicated below.

Nobuo SASAKI			
Name of First or Sole Inventor	Execution Date of U.S. Patent Application		
Kitnagama , Japan			
Residence of First or Sole Inventor			
Chobin Sasahi	19/10/2001		
Signature of First or Sole Inventor	Date of this Assignment		

Docket Number: SCEI -3.0-081 SCEI Ref. No.: SC01054US00

Masaaki UKA		
Name of Second Joint Inventor	11	
Kanaga/a, Japan Residence of Second Joint Inventor		
Residence of Second Joint Inventor		
Masaaki Oka	Oct. 19, 2001 Date of this Assignment	
Signature of Second Joint Inventor	Date of this Assignment	
Name of Third Joint Inventor	Execution Date of U.S. Patent Application	
Residence of Third Joint Inventor		
Signature of Third Joint Inventor	Date of this Assignment	
Name of Fourth Joint Inventor	Execution Date of U.S. Patent Application	
Residence of Fourth Joint Inventor		
Signature of Fourth Joint Inventor	Date of this Assignment	
Name of Fifth Joint Inventor	Execution Date of U.S. Patent Application	
Residence of Fifth Joint Inventor		
Signature of Fifth Joint Inventor	Date of this Assignment	

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RECORDED: 01/03/2002

PATENT REEL: 012439 FRAME: 0875